To our customers,

Old Company Name in Catalogs and Other Documents

On April 1st, 2010, NEC Electronics Corporation merged with Renesas Technology Corporation, and Renesas Electronics Corporation took over all the business of both companies. Therefore, although the old company name remains in this document, it is a valid Renesas Electronics document. We appreciate your understanding.

Renesas Electronics website: http://www.renesas.com

April 1st, 2010
Renesas Electronics Corporation

Issued by: Renesas Electronics Corporation (http://www.renesas.com)

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Solid State Relay
OCMOS FET

PS7241E-1A

4-PIN SOP 400 V BREAK DOWN VOLTAGE NORMALLY OPEN TYPE 1-ch Optical Coupled MOS FET

–NEPOC Series–

DESCRIPTION

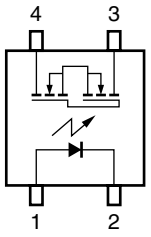
The PS7241E-1A is an optically coupled element that combines a GaAs infrared LED on the input side with a normally-open MOS FET on the output side to realize an excellent cost performance.

The small, thin package and high sensitivity of this element makes it ideal for battery-driven mobile devices, and its small offset voltage at power-on and good linearity are also make it suitable for controlling micro analog signals.

FEATURES

- Small and thin package (4-pin SOP, Height = 2.1 mm)
- 1 channel type (1 a output)
- Designed for AC/DC switching line changer
- Low offset voltage
- <R> Ordering number of taping product: PS7241E-1A-E3, E4: 900 pcs/reel
  : PS7241E-1A-F3, F4: 3 500 pcs/reel
- Pb-Free product
- Safety standards
  - UL approved: No. E72422
  - BSI approved: No. 8241/8242

PIN CONNECTION
(Top View)



1. LED Anode
2. LED Cathode
3. MOS FET
4. MOS FET

APPLICATIONS

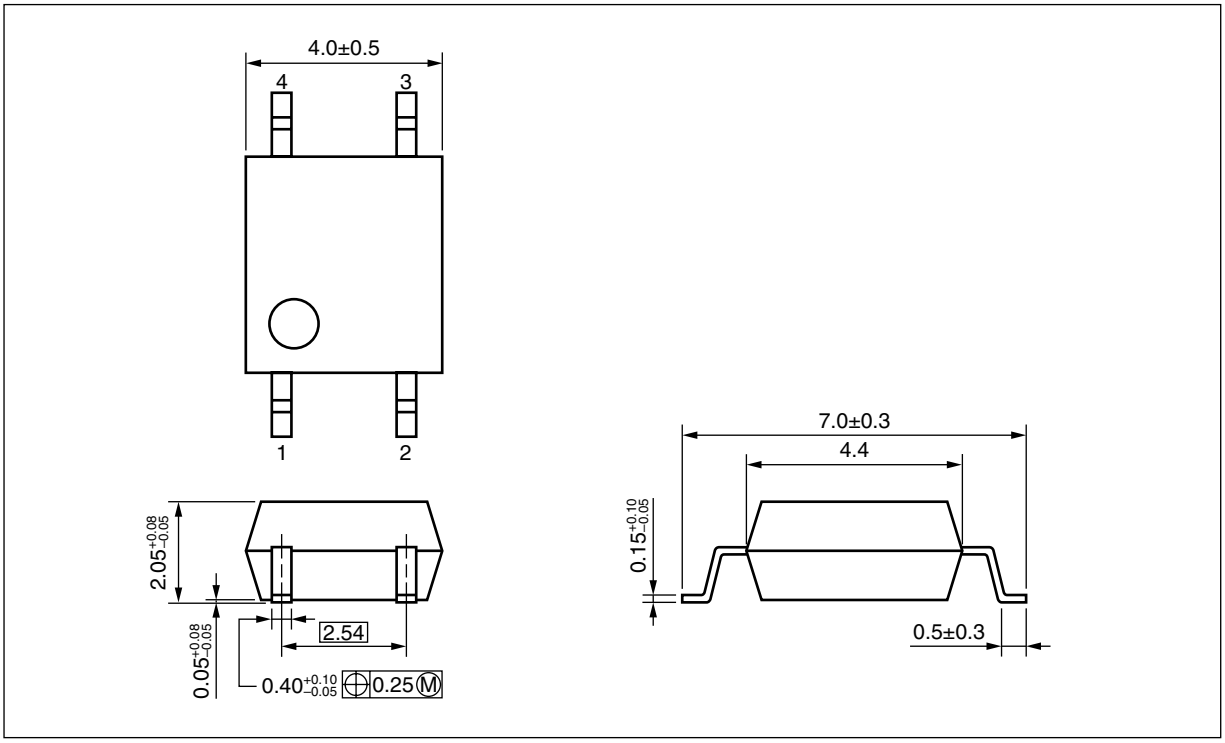
- Laptop PC, PDA
- Modem card
- Telephone, FAX
- Measurement equipment

Document No. PN10459EJ04V0DS (4th edition)
Date Published January 2010 NS
Printed in Japan

The mark <R> shows major revised points.

The revised points can be easily searched by copying an "<R>" in the PDF file and specifying it in the "Find what:" field.

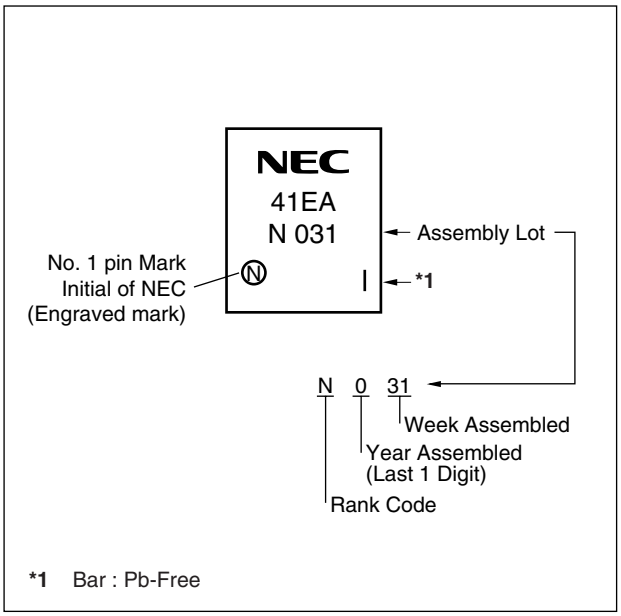
PACKAGE DIMENSIONS (UNIT: mm)



<R> PHOTOCOUPLER CONSTRUCTION

Parameter	Unit (MIN.)
Air Distance	5 mm
Outer Creepage Distance	5 mm
Isolation Distance	0.4 mm

<R> MARKING EXAMPLE



1 Bar : Pb-Free

ORDERING INFORMATION

Part Number	Order Number	Solder Plating Specification	Packing Style	Safety Standard Approval	Application Part Number*1
PS7241E-1A	PS7241E-1A-A	Pb-Free	Magazine case 100 pcs	Standard products (UL, BSI approved)	PS7241E-1A
PS7241E-1A-E3	PS7241E-1A-E3-A		Embossed Tape 900 pcs/reel		
PS7241E-1A-E4	PS7241E-1A-E4-A				
PS7241E-1A-F3	PS7241E-1A-F3-A		Embossed Tape 3 500 pcs/reel		
PS7241E-1A-F4	PS7241E-1A-F4-A				

***1** For the application of the Safety Standard, following part number should be used.

ABSOLUTE MAXIMUM RATINGS (T_A = 25°C, unless otherwise specified)

Parameter		Symbol	Ratings	Unit
Diode	Forward Current (DC)	I_F	50	mA
	Reverse Voltage	V_R	5.0	V
	Power Dissipation	P_D	50	mW
	Peak Forward Current*1	I_{FP}	1	A
MOS FET	Break Down Voltage	V_L	400	V
	Continuous Load Current	I_L	120	mA
	Pulse Load Current*2 (AC/DC Connection)	I_{LP}	240	mA
	Power Dissipation	P_D	300	mW
Isolation Voltage*3		BV	1 500	Vr.m.s.
Total Power Dissipation		P_T	350	mW
Operating Ambient Temperature		T_A	–40 to +85	°C
Storage Temperature		T_{stg}	–40 to +100	°C

***1** PW = 100 μs, Duty Cycle = 1%

***2** PW = 100 ms, 1 shot

***3** AC voltage for 1 minute at T_A = 25°C, RH = 60% between input and output.
Pins 1-2 shorted together, 3-4 shorted together.

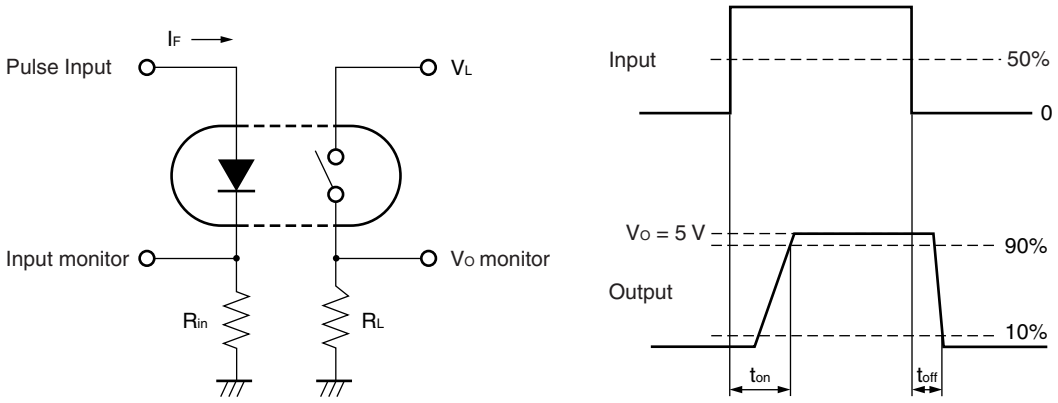
RECOMMENDED OPERATING CONDITIONS (T_A = 25°C)

Parameter	Symbol	MIN.	TYP.	MAX.	Unit
LED Operating Current	I_F	4	10	20	mA
LED Off Voltage	V_F	0		0.5	V

ELECTRICAL CHARACTERISTICS (T_A = 25°C)

	Parameter		Symbol	Conditions	MIN.	TYP.	MAX.	Unit
	Diode	Forward Voltage	V_F	I_F = 10 mA		1.2	1.4	V
		Reverse Current	I_R	V_R = 5 V			5.0	μA
	MOS FET	Off-state Leakage Current	I_{Loff}	V_D = 400 V			1.0	μA
<R>		Output Capacitance	C_{out}	V_D = 0 V, f = 1 MHz		50		pF
	Coupled	LED On-state Current	I_{Fon}	I_L = 120 mA			4.0	mA
<R>		On-state Resistance	R_{on1}	I_F = 10 mA, I_L = 10 mA		22	30	Ω
			R_{on2}	I_F = 10 mA, I_L = 120 mA, t ≤ 10 ms		17	23	
		Turn-on Time*1, 2	t_{on}	I_F = 10 mA, V_O = 5 V, R_L = 500 Ω,		0.5	1.0	ms
		Turn-off Time*1, 2	t_{off}	PW ≥ 10 ms		0.07	0.2	
		Isolation Resistance	R_{I-O}	V_{I-O} = 1.0 kV_{DC}	10^9			Ω
		Isolation Capacitance	C_{I-O}	V = 0 V, f = 1 MHz		0.5		pF

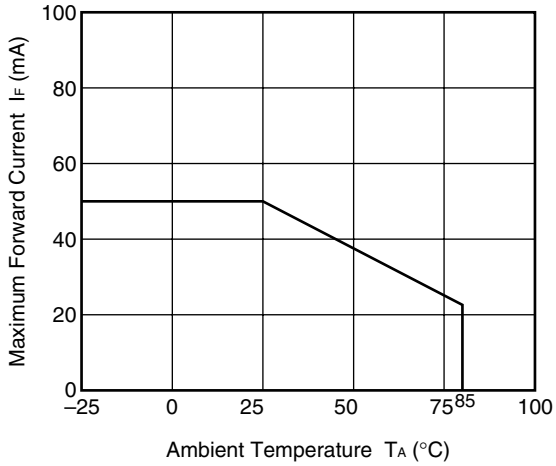
***1** Test Circuit for Switching Time



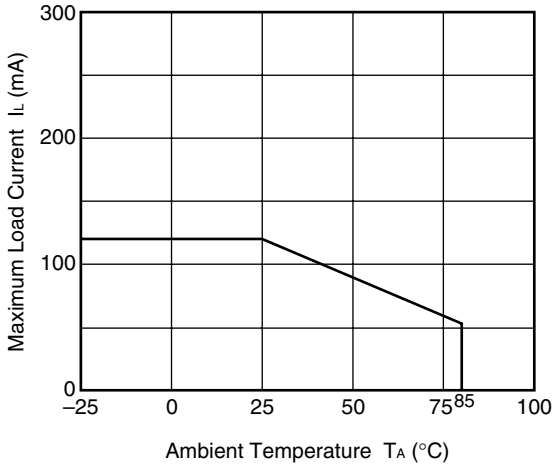
***2** The turn-on time and turn-off time are specified as input-pulse width ≥ 10 ms.
Be aware that when the device operates with an input-pulse width less than 10 ms, the turn-on time and turn-off time will increase.

TYPICAL CHARACTERISTICS (T_A = 25°C, unless otherwise specified)

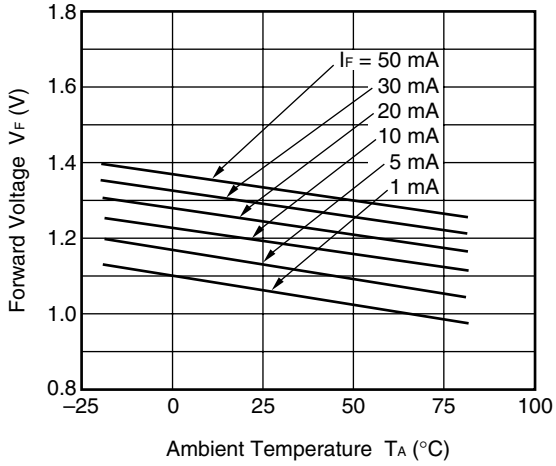
MAXIMUM FORWARD CURRENT vs. AMBIENT TEMPERATURE



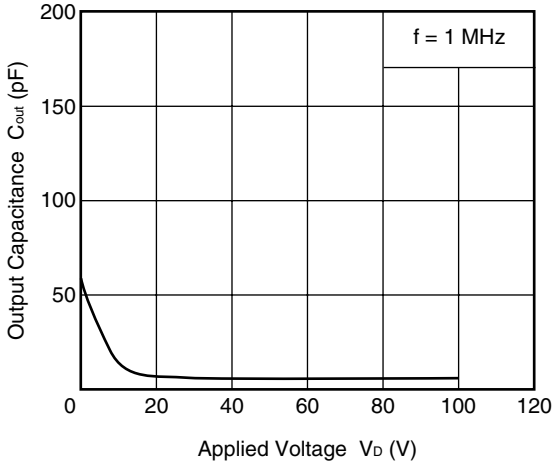
MAXIMUM LOAD CURRENT vs. AMBIENT TEMPERATURE



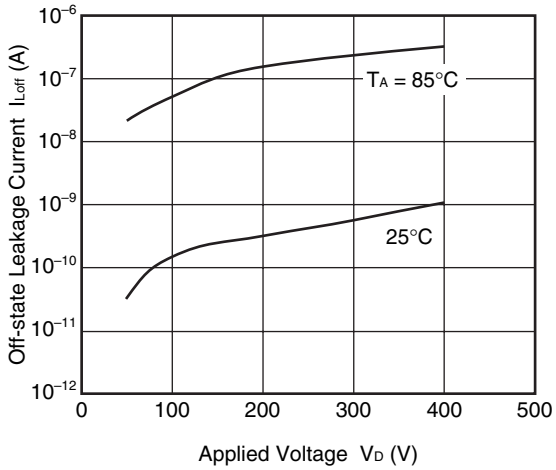
FORWARD VOLTAGE vs. AMBIENT TEMPERATURE



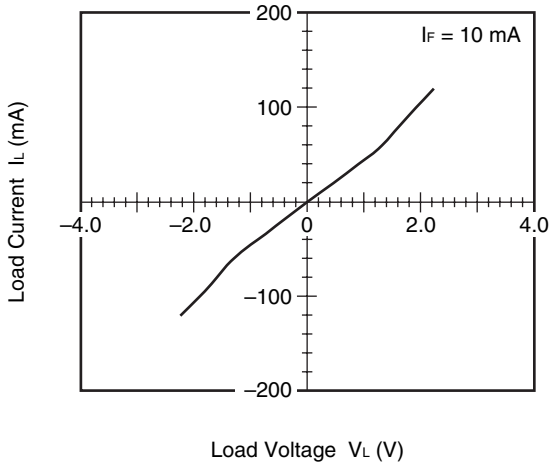
OUTPUT CAPACITANCE vs. APPLIED VOLTAGE



OFF-STATE LEAKAGE CURRENT vs. APPLIED VOLTAGE

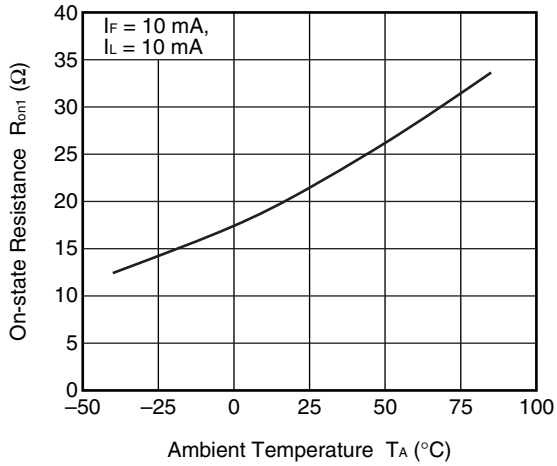


LOAD CURRENT vs. LOAD VOLTAGE

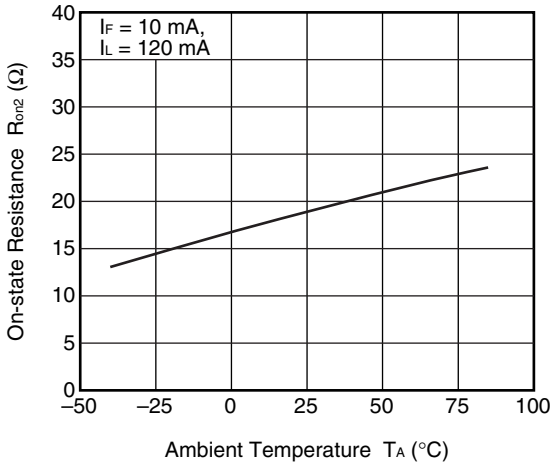


Remark The graphs indicate nominal characteristics.

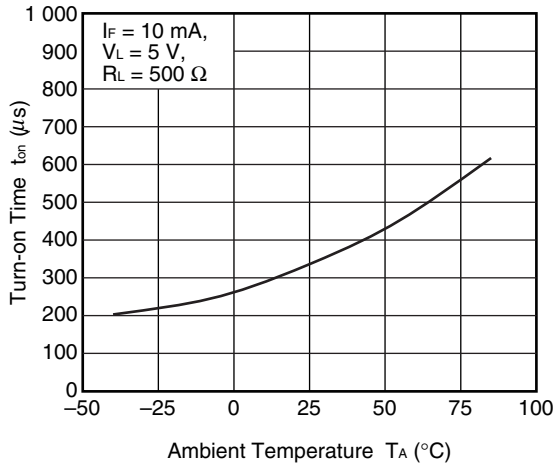
ON-STATE RESISTANCE vs.
AMBIENT TEMPERATURE



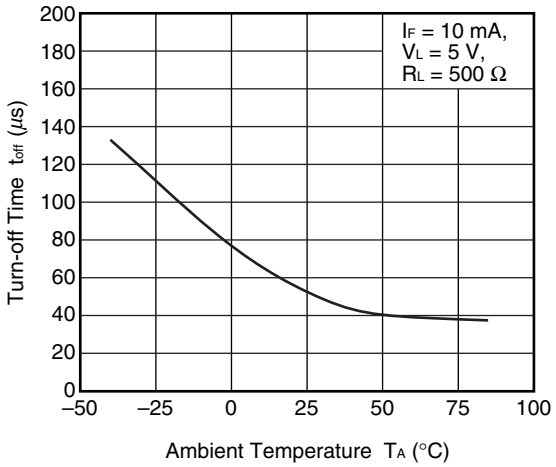
ON-STATE RESISTANCE vs.
AMBIENT TEMPERATURE



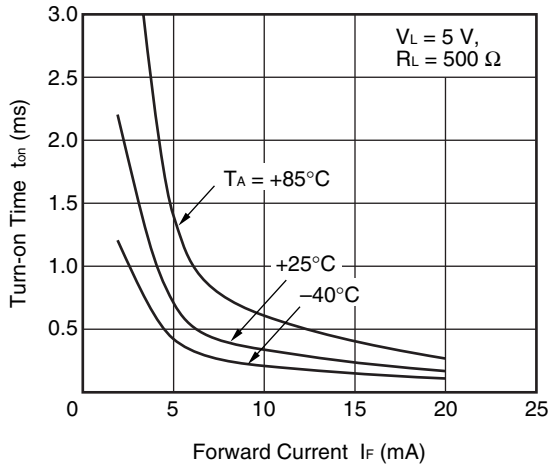
TURN-ON TIME vs.
AMBIENT TEMPERATURE



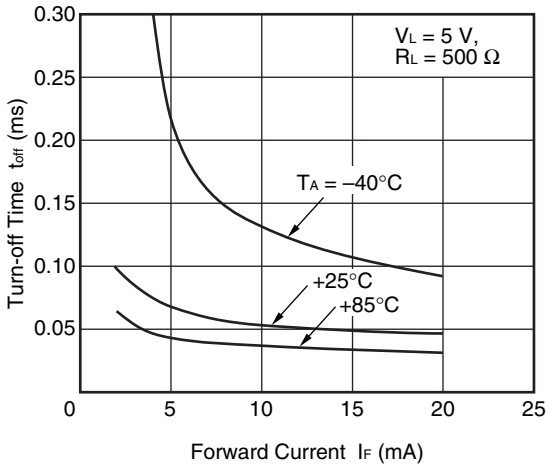
TURN-OFF TIME vs.
AMBIENT TEMPERATURE



TURN-ON TIME vs. FORWARD CURRENT

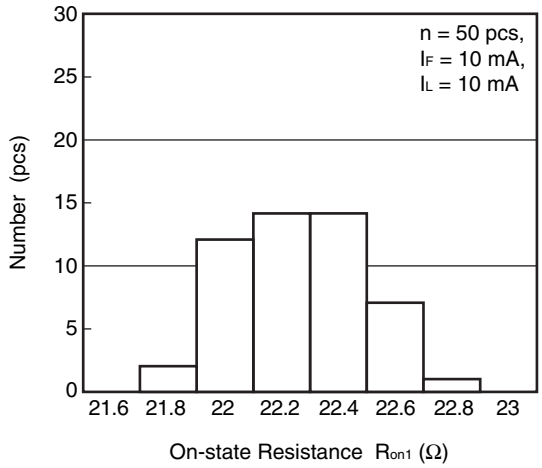


TURN-OFF TIME vs. FORWARD CURRENT

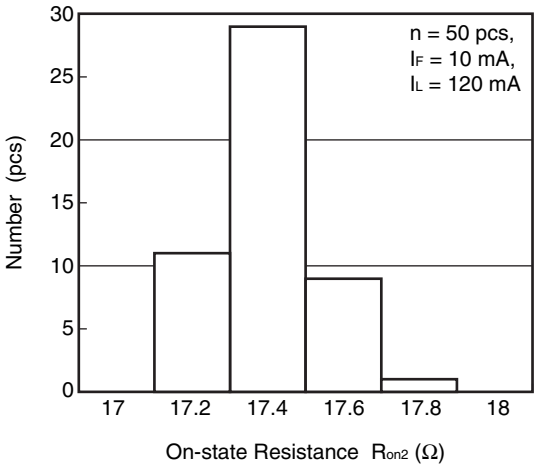


Remark The graphs indicate nominal characteristics.

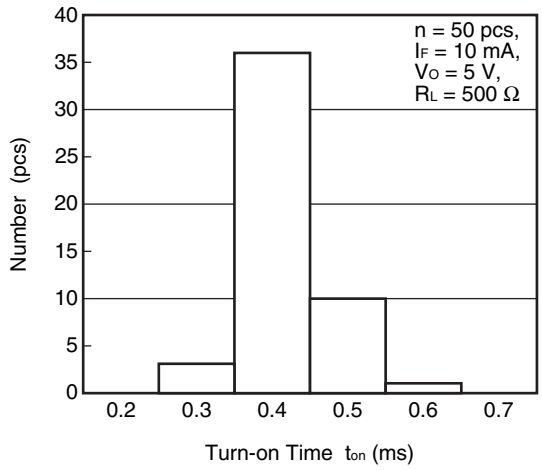
ON-STATE RESISTANCE DISTRIBUTION



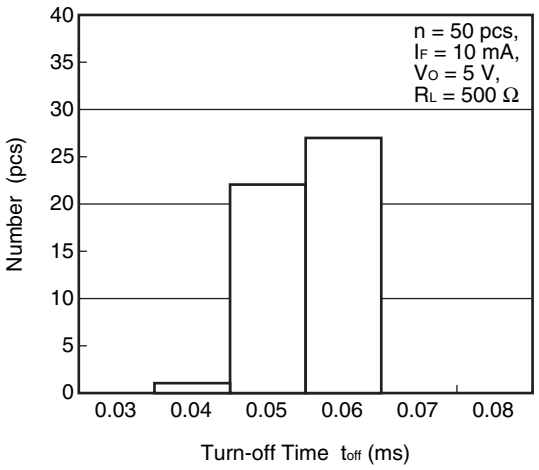
ON-STATE RESISTANCE DISTRIBUTION



TURN-ON TIME DISTRIBUTION



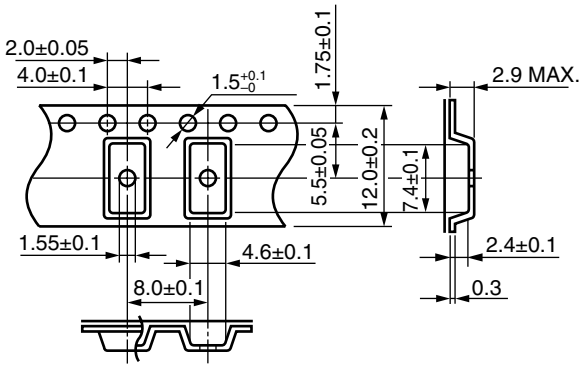
TURN-OFF TIME DISTRIBUTION



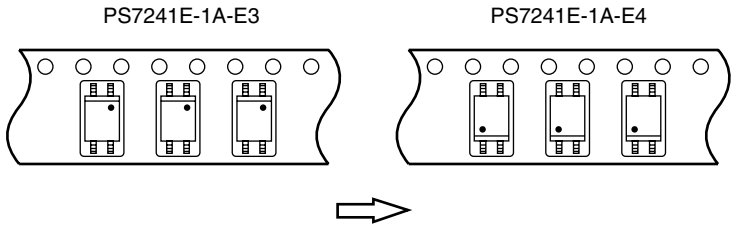
Remark The graphs indicate nominal characteristics.

TAPING SPECIFICATIONS (in millimeters)

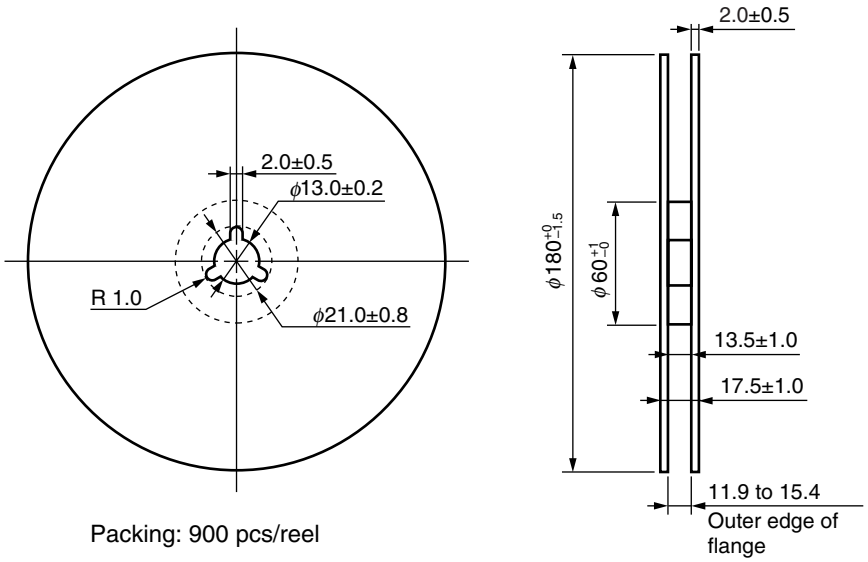
Outline and Dimensions (Tape)



Tape Direction

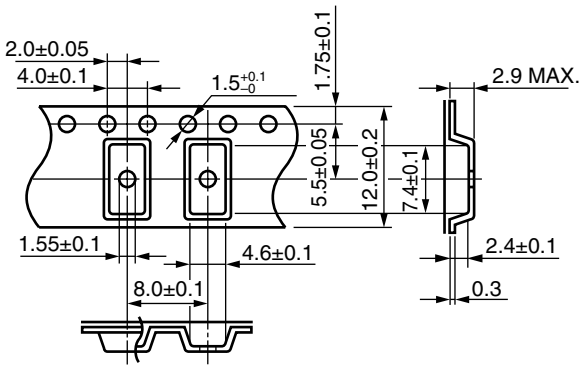


Outline and Dimensions (Reel)

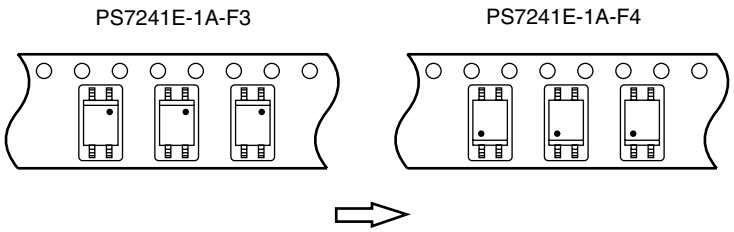


Packing: 900 pcs/reel

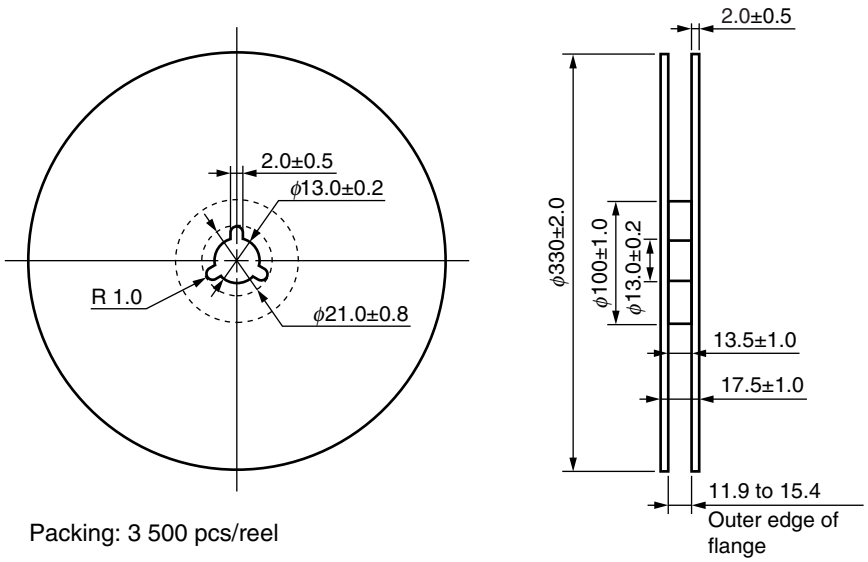
Outline and Dimensions (Tape)



Tape Direction



Outline and Dimensions (Reel)



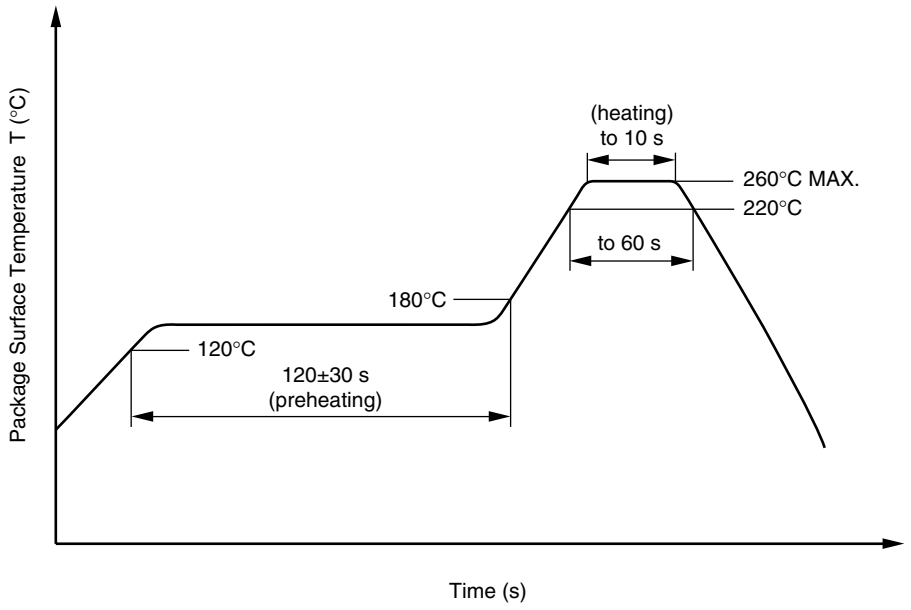
Packing: 3 500 pcs/reel

RECOMMENDED SOLDERING CONDITIONS

(1) Infrared reflow soldering

- Peak reflow temperature — 260°C or below (package surface temperature)
- Time of peak reflow temperature — 10 seconds or less
- Time of temperature higher than 220°C — 60 seconds or less
- Time to preheat temperature from 120 to 180°C — 120±30 s
- Number of reflows — Three
- Flux — Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of 0.2 Wt% is recommended.)

Recommended Temperature Profile of Infrared Reflow



(2) Wave soldering

- Temperature — 260°C or below (molten solder temperature)
- Time — 10 seconds or less
- Preheating conditions — 120°C or below (package surface temperature)
- Number of times — One
- Flux — Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of 0.2 Wt% is recommended.)

(3) Soldering by soldering iron

- Peak temperature (lead part temperature) — 350°C or below
- Time (each pins) — 3 seconds or less
- Flux — Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of 0.2 Wt% is recommended.)

(a) Soldering of leads should be made at the point 1.5 to 2.0 mm from the root of the lead.

(b) Please be sure that the temperature of the package would not be heated over 100°C.

(4) Cautions

- Fluxes

  Avoid removing the residual flux with freon-based and chlorine-based cleaning solvent.

USAGE CAUTIONS

1. Protect against static electricity when handling.

2. Avoid storage at a high temperature and high humidity.

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(Note)
(1) "NEC Electronics" as used in this statement means NEC Electronics Corporation and also includes its majority-owned subsidiaries.
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Caution GaAs Products	This product uses gallium arsenide (GaAs). GaAs vapor and powder are hazardous to human health if inhaled or ingested, so please observe the following points. • Follow related laws and ordinances when disposing of the product. If there are no applicable laws and/or ordinances, dispose of the product as recommended below. 1. Commission a disposal company able to (with a license to) collect, transport and dispose of materials that contain arsenic and other such industrial waste materials. 2. Exclude the product from general industrial waste and household garbage, and ensure that the product is controlled (as industrial waste subject to special control) up until final disposal. • Do not burn, destroy, cut, crush, or chemically dissolve the product. • Do not lick the product or in any way allow it to enter the mouth.